

LOCTITE M 2000RS MOD2 E&C

September 2016

PRODUCT DESCRIPTION

LOCTITE M 2000RS MOD2 E&C provides the following product characteristics:

Technology	Thermosetting					
Appearance	Black					
Product Benefits	 One component Applicable with manual or semi automatic screen printing equipment Good screen residence time Can be mixed to produce accurately controlled resistance values Less than 5% resistance changes after soldering, humidity and thermal ageing exposure 					
Cure	Heat cure					
Application	Conductive Ink					
Typical Assembly Applications	Printed resistors and Potentiometers					
Key Substrates	FR-3, FR-4, CEM-1 and CEM-3 polyether sulphone and ceramic substrates					

LOCTITE M 2000RS MOD2 E&C of products are specifically designed for printing potentiometers and resistors onto printed circuit boards. LOCTITE M 2000RS MOD2 E&C is the improved sliding version of the standard Minico M2000 RS Series.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity35,000, ASTM D2393, mPa·s (cP)	35,000
Density, kg/cm³	1,300
Shelf Life @ 18 to 25° C (from date of qualification original seal), hour	in 1
Flash Point , °C	78

TYPICAL SCREEN PRINTING PROCESS

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Emulsion Thickness	
Direct or indirect emulsion µm	25 to 50
Printing Equipment Type	
Manual	
Semi-automatic	
Recommended Screen Type	
Monofilament polyester & Stainless Steel threads/cm	77 to 100
Recommended Squeegee	
Polyurethane , Shore Hardness	70 to 80
Speed (not to exceed), cm/s	10
Applied Dry Coating Thickness	
Applied Dry Coating Thickness, µm	15 to 25

TYPICAL DRYING CYCLE

5 to 10 minutes @ 120 °C:

TYPICAL CURING PERFORMANCE

Convection Box Oven

30 minutes @ 200°C

Infrared Heat Source

6 minutes @ 200°C

If different resistors are applied on the same board, it is not advisable to cure each resistor type individually. It is recommended to dry each resistor after printing @ 120 °C. Full cure at 200°C should be performed after printing the last resistor type.

These cure schedules are a general guideline for additive circuitry. Other cure schedules can be utilized depending on laminates and processing parameters.

The above cure profile is a guideline recommendation. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

As a cured coating

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Adhesion, ASTM 3359 Method B, grade	5B
Electrical Properties	
Temperature Coefficient of Resistance (TCR), ppm	200
Resistivity, ohms/square/25 µm ±15%:	
M 2001 RS E&C	1
M 2010 RS MOD2 E&C	10
M 2012 RS MOD2 E&C	100
M 2013 RS MOD2 E&C	1,000
M 2014 RS MOD2 E&C	10,000
M 2015 RS MOD2 E&C	100,000

GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

DIRECTIONS FOR USE

- LOCTITE M 2000RS MOD2 E&C should be thoroughly stirred prior to use. Avoid rapid stirring as this causes air entrapment..
- Should thinning become necessary, dilute (not to exceed)1% by weight with butyl carbitol.



STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Store in a cool, well ventilated area.

Optimal Storage: 18 to 25 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

Disclaimer

Note:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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